

C1210X911MATACTU

Aliases (C1210X911MATAC7800) SMD Comm X8G HT150C Flex, Ceramic, 910 pF, 20%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	30 mg
Shelf Life	78 Weeks
MSL	1

	Specifications	
)	Capacitance	910 pF
mm +/-0.4mm	Measurement Condition	1 MHz 1.0Vrms
mm +/-0.3mm	Tolerance	20%
3mm +/-0.20mm	Voltage DC	250 VDC
nm MIN	Dielectric Withstanding Voltage	625 VDC
mm +/-0.25mm	Temperature Range	-55/+150°C
	Temp. Coefficient	X8G
R, 180mm, Plastic Tape 00	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
	Dissipation Factor	0.1% 1 MHz 1.0Vrms

Aging Rate

Insulation Resistance

 Dimensions

 Chip Size
 1210

 L
 3.3mm +/-0.4mm

 W
 2.6mm +/-0.3mm

 T
 0.78mm +/-0.20mm

 S
 1.5mm MIN

 B
 0.6mm +/-0.25mm

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

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0% Loss/Decade Hour: Referee

Time is 1000 Hours

100 GOhms